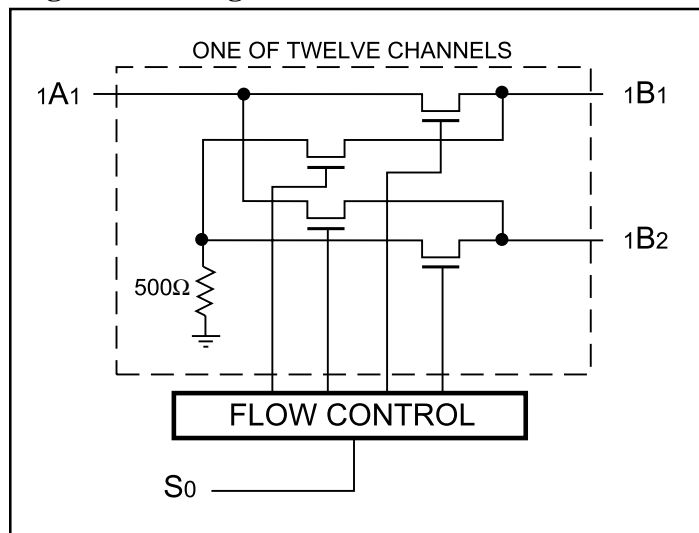# PERICOM

3.3Volt, 24-Bit Mux/Demux BusSwitch

Features

- Near-zero propagation delay
- 5Ω switches connect inputs to outputs
- Fast Switching Speed - 5ns (max.)(16292)
- Internal 500Ω pull-down on A2 ports
- Ultra-low quiescent power (0.2μA typical) – Ideally suited for notebook applications
- Vcc Operating Range : 3.0V to 3.6V
- Industrial operating temperature: –40°C to +85°C
- Make-before-break switching
- Packages available:
  – 56-pin 240-mil wide thin plastic TSSOP (A)
  – 56-pin 300-mil wide plastic SSOP (V)

Applications

- Memory switching

Logic Block Diagram

Truth Table

Function	S0	A1	A2
A1 to B1, A2 to B2	L	B1	B2
A1 to B2, A2 to B1	H	B2	B1

Note:
1. H = High Voltage Level
   L = Low Voltage Level
   Z = High Impedance

Description

Pericom Semiconductor's PI3B series of logic circuits are produced using the Company's advanced 0.35 micron CMOS technology.

The PI3B16292 and PI3B162292 are 3.3 volt, 12-bit to 24-bit Mux/Demux Bus switches designed with a low ON resistance allowing inputs to be connected directly to outputs.

The PI3B162292 device has a built-in 25-ohm series resistor to reduce noise resulting from reflections, thus eliminating the need for an external terminating resistor.

A2 port is not externally connected and, as a result, has an internal 500-ohm pulldown resistor to ground.

Pin Configuration

Product Pin Description

Pin Name	I/O	Description
S_0	I	Select Inputs
xA1	I/O	Bus A
xBx	I/O	Bus B
NC		Leave it unconnected
NC1		Leave it unconnected

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–65°C to +150°C
Ambient Temperature with Power Applied	–0°C to +85°C
Supply Voltage Range	–0.5V to +4.6V
DC Input Voltage	–0.5V to +4.6V
DC Output Current	120 mA
Power Dissipation	0.5Watt

Note:
Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, T_A = –40°C to +85°C, V_{CC} = 3.0V to 3.6V)

Parameters	Description	Test Conditions[1]		Min.	Typ[2]	Max.	Units
V_{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level		2.0	—	—	V
V_{IL}	Input LOW Voltage	Guaranteed Logic LOW Level		–0.5	—	0.8	V
I_I	Input Current	V_{CC} = Max., V_{IN} = V_{CC} or GND		—	—	±1	µA
		V_{CC} = 0, V_{IN} = V_{CC}		—	—	10	µA
V_{IK}	Clamp Diode Voltage	V_{CC} = Min., I_{IN} = –18mA		—	–0.7	–1.2	V
R_{ON}	Switch On Resistance[3]	V_{CC} = Min., V_{IN} = 0.0V,	16292	—	5	8	Ω
		I_{ON} = 64mA	162292	20	28	40	
		V_{CC} = Min., V_{IN} = 2.4V,	16292	—	10	15	Ω
		I_{ON} = 15mA	162292	20	35	48	

Capacitance (T_A = 25°C, f = 1 MHz)

Parameters[4]	Description	Test Conditions	Max.	Units
C_{IN}	Input Capacitance	V_{IN} = 0V	3.0	pF
C_{ON}	A/B Capacitance, Switch On	V_{IN} = 0V	30.0	pF

Notes:
1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
2. Typical values are at V_{cc} = 3.3V, T_A = 25°C ambient and maximum loading.
3. Measured by the voltage drop between A and B pin at indicated current through the switch. ON resistance is determined by the lower of the voltages on the two (A,B) pins.
4. This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions[1]		Min.	Typ[2]	Max.	Units
I_{CC}	Quiescent Power Supply Current	V_{CC} = MAX.	V_{IN} = GND or V_{CC}	—	—	10	μA
ΔI_{CC}[3]	Supply Current for S0 @ TTL HIGH	V_{CC} = MAX.	V_{IN} = 3.0 V[4] Other Inputs at V_{CC} OR GND	—	—	750	μA
I_{CCD}	Supply Current for S0 per MHz[5] Toggling 50% Duty Cycle	V_{CC} = Max., A and B Pins Open		—	—	0.25	mA/ MHz

Notes:
1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for applicable device.
2. Typical values are at Vcc = 3.3V, +25°C ambient.
3. This is the increase in supply current for S0 at the specified TTL voltage level rather than V_{CC} or GND.
4. Per driven input (S0 only); A and B pins do not contribute to Icc.
5. This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is not tested, but is guaranteed by design.

PI3B16292 Switching Characteristics over Operating Range

Parameters	Description	Conditions[1]	Com.		Units
			Min.	Max.	
t_{PLH} t_{PHL}	Propagation Delay[2,3] xA1 to xBx, xBx to xA1		—	0.25	ns
t_{PZH} t_{PZL}	Bus Enable time S to xA1 or xBx	C_L = 50 pF R_L = 500Ω	1	4.5	
t_{PHZ} t_{PLZ}	Bus Disable time S to xA1 or xBx	R = 500Ω to 6V[4]	1	5.0	
t_m	Make-before-break time[2]		0	2	

PI3B162292 Switching Characteristics over Operating Range

Parameters	Description	Conditions[1]	Com.		Units
			Min.	Max.	
t_{PLH} t_{PHL}	Propagation Delay[2,3] xA1 to xBx, xBx to xA1		—	1.25	ns
t_{PZH} t_{PZL}	Bus Enable time S to xA1 or xBx	C_L = 50 pF R_L = 500Ω	1	5	
t_{PHZ} t_{PLZ}	Bus Disable time S to xA1 or xBx	R = 500Ω to 4.6V[4]	1	5.5	
t_m	Make-before-break time[2]		0	2	

Notes:
1. See test circuit and waveforms.
2. This parameter is guaranteed but not tested.
3. The bus switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.
4. Applies to t_{PLZ} and t_{PZL}.

56-Pin SSOP (300 MIL WIDE) - Package Code: V56


```
.291    .396
.299    .416
7.39   10.06
7.59   10.56
```

Gauge Plane

```
.010  0.25          .02
                    .04
                    0.51
                    1.01
```

```
.720
.730
18.29
18.54
```

```
.025 BSC          .008
0.635             .0135
                  0.20
                  0.34
```

```
.015  0.381  x 45°
.025  0.635
```

```
.008  0.20 Nom.          .110  2.79  Max
```

```
0-8°              .008  0.20
                  .016  0.40
```

X.XX DENOTES DIMENSIONS
X.XX IN MILLIMETERS
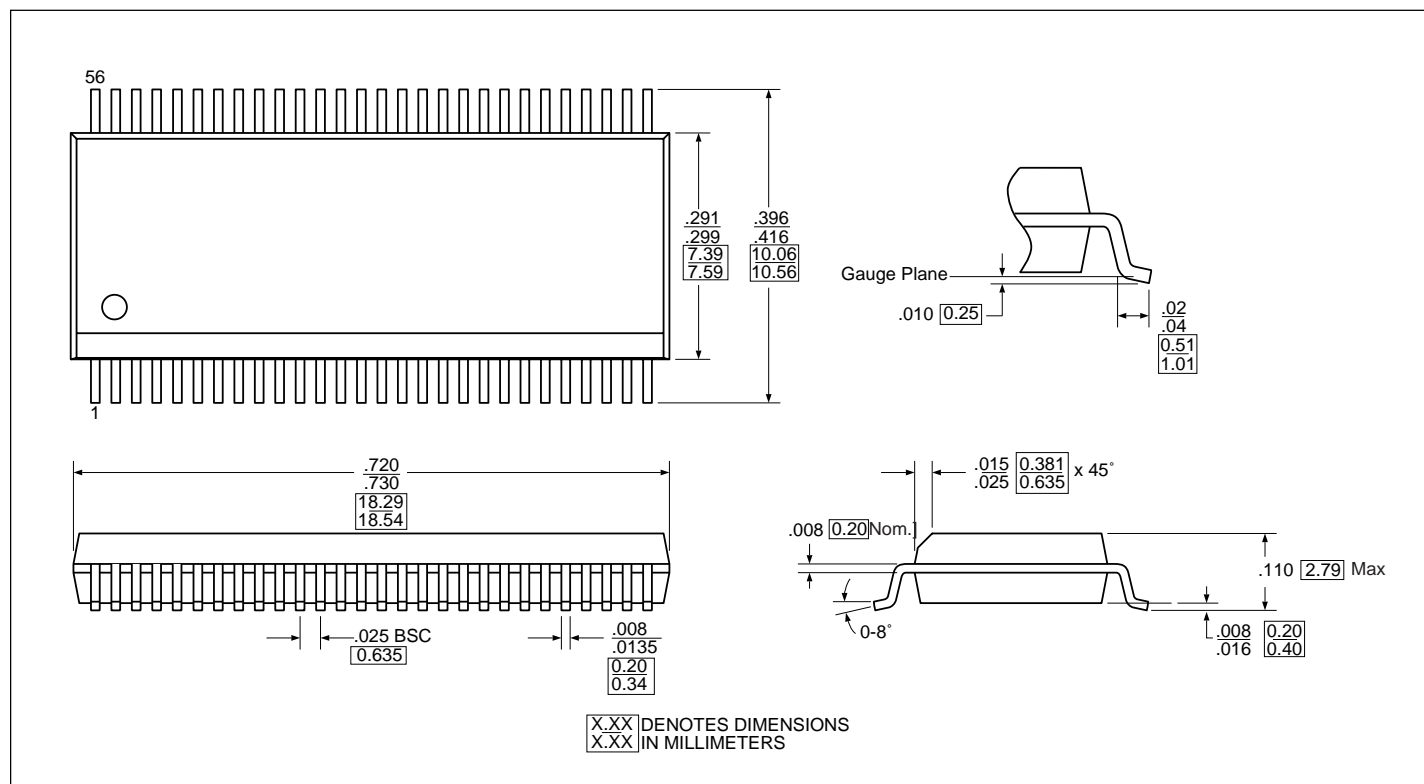
56-Pin TSSOP (240 MIL WIDE) - Package Code: A56


```
.236  6.0
.244  6.2
```

```
.547  13.9
.555  14.1
```

SEATING PLANE

```
1.20  .047
      Max.
```

```
.0197          .07       .002
BSC            .011       .006
0.50           0.17       0.05
               0.27       0.15
```

```
.004  0.09
.008  0.20
```

```
0.45  .018
0.75  .030
```

```
.319
BSC
8.1
```

X.XX DENOTES DIMENSIONS IN MILLIMETERS
X.XX